









PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 0603 (1608) 0.55t
- ➤ Yellow (590nm) / Green (570nm)

N0D28S40



0603 (1608) 0.55t





Release Date: 29 February 2016 Version: A1.0

0603 (1608) 0.8t

APPLICATIONS:

- Indication Light
- Switch light
- Dashboard
- 3C Consumer Goods

FEATURES:

- Package: PCB / CHIP LED Dual Colour Top View LED
- Forward Current: 20/20mA* Forward Voltage (typ.): 2.0/2.0V
- Luminous Intensity (typ.): 60/30mcd @20mA
- Colour: Yellow/Green Wavelength: 590/570nm Viewing angle: 140/140°
- **Materials:**
 - Die: AlGaInP/AlGaInP Resin: Epoxy (Water Clear) Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with 4000/reel, ø180mm (7")

^{*} in the order of Yellow/Green



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30/30*	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125/125	mA
Reverse Current @5V	I _R	10/10	μΑ
Power Dissipation	P _D	75/75	mW
Operating Temperature	T_OPR	-40~+80	°C
Storage Temperature	T _{STG}	-40~+85	°C

^{*} in the order of Yellow/Green

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values		Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V_{F}	1.7/1.7	2.0/2.0	2.5/2.5	V	I _F =20mA
Luminous Intensity	I _V	40/20	60/30	125/63	mcd	I _F =20mA
Dominant Wavelength	$\lambda_{\scriptscriptstyle D}$	585/565	590/570	595/576	nm	I _F =20mA
Peak Wavelength	$\lambda_{ extsf{P}}$		592/572		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		17/17		nm	I _F =20mA
Viewing Angle	2θ _{1/2}		140/140		deg	I _F =20mA

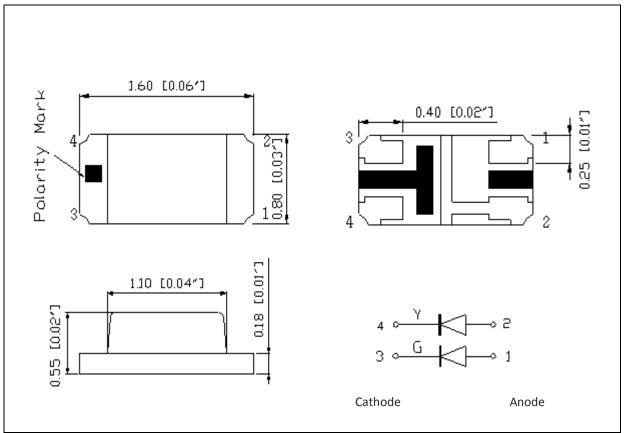
^{1.} In the order of Yellow/Green

^{2.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V



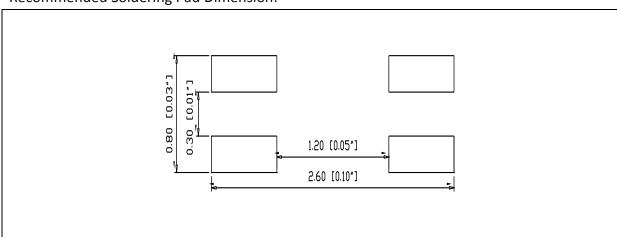
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
Yellow	1.7	2.5	V
Green	1.7	2.5	V

Luminous Intensity Classifications (I_F = 20mA):

Со	de	Min.	Max.	Unit
	F	40	50	
	G	50	63	
Yellow	Н	63	80	mcd
	1	80	100	
	J	100	125	

Co	de	Min.	Max.	Unit
	С	20	25	
	D	25	32	
Green	E	32	40	mcd
	F	40	50	
	G	50	63	

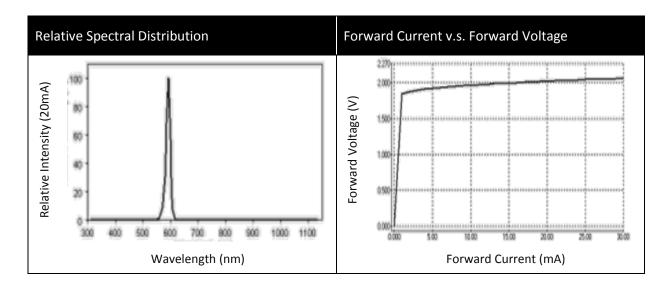
Dominant Wavelength Classifications ($I_F = 20$ mA):

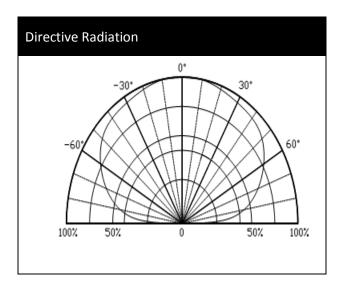
Co	ode	Min.	Max.	Unit
Yellow	М	585	590	
Yellow	N	590	595	nm

Со	de	Min.	Max.	Unit
	н	565	568	
Green	1	568	572	nm
	J	572	576	



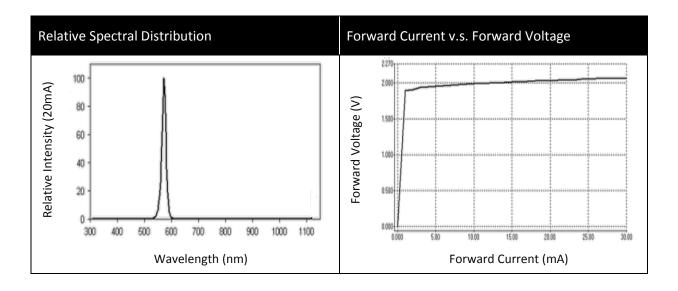
ELECTRO-OPTICAL CHARACTERISTICS (Yellow):

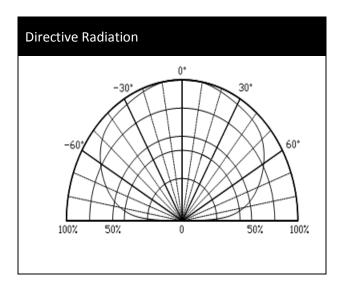






ELECTRO-OPTICAL CHARACTERISTICS (Green):

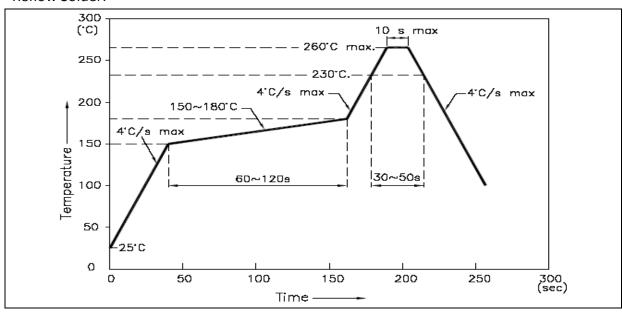






RECOMMENDED SOLDERING PROFILE:

Reflow Solder:



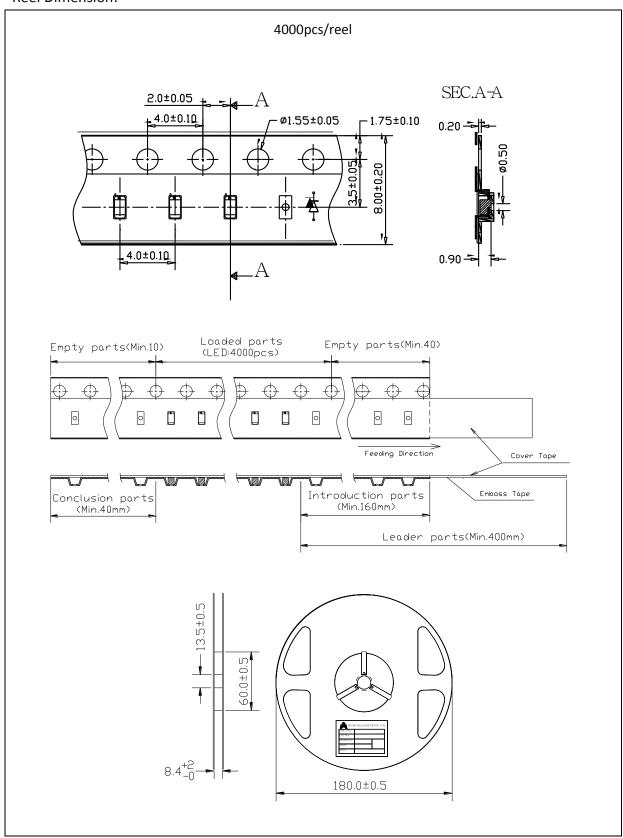
Note:

- 1. Recommend reflow temperature 245°C. Maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

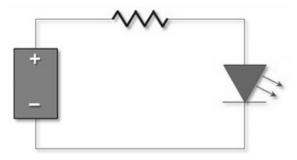
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	29/02/2016	Datasheet set-up.